

**Digital Attenuator**  
**30.0 dB, 4-Bit, TTL Driver, DC-2.5 GHz**

**MAATCC0012**  
**V3**

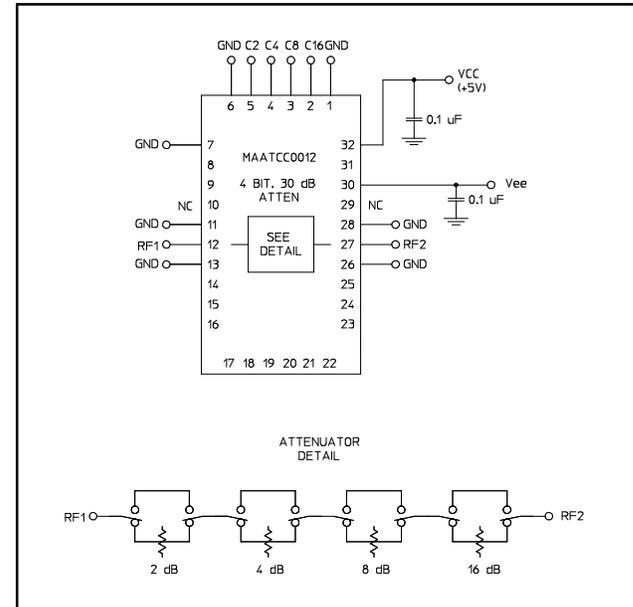
**Features**

- Attenuation: 2 dB Steps to 30 dB
- Low DC Power Consumption
- Small Footprint, JEDEC Package
- Integral TTL Driver
- 50 Ohm Impedance
- Test Boards Available
- Tape and Reel Packaging Available
- Lead-Free CSP-1 Package
- 100% Matte Tin Plating over Copper
- Halogen-Free “Green” Mold Compound
- 260°C Reflow Compatible
- RoHS\* Compliant Version of AT90-0233

**Description**

M/A-COM’s MAATCC0012 is a GaAs FET 4-Bit digital attenuator with integral driver. Step size is 2 dB providing a 30 dB attenuation range. This device is in an PQFN plastic surface mount package. The MAATCC0012 is suited for use where accuracy, fast speed, very low power consumption and low costs are required.

**Schematic with Off-Chip Components**



**Pin Configuration**

Pin No.	Function	Pin No.	Function
1	GND	17	N/C
2	C16	18	N/C
3	C8	19	N/C
4	C4	20	N/C
5	C2	21	N/C
6	GND	22	N/C
7	GND	23	N/C
8	N/C	24	N/C
9	N/C	25	N/C
10	N/C <sup>1</sup>	26	GND
11	GND	27	RF2
12	RF1	28	GND
13	GND	29	N/C <sup>1</sup>
14	N/C	30	VEE
15	N/C	31	N/C
16	N/C	32	Vcc

1. Pins 10 and 29 must be isolated.
2. The exposed pad centered on the package bottom must be connected to RF and DC ground. (For PQFN Packages)

**Ordering Information**

Part Number	Package
MAATCC0012	Bulk Packaging
MAATCC0012TR	1000 piece reel
MAATCC0012-TB	Sample Test Board

Note: Reference Application Note M513 for reel size information.  
Note: Die quantity varies.

\* Restrictions on Hazardous Substances, European Union Directive

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**Electrical Specifications:  $T_A = +25^\circ\text{C}$**

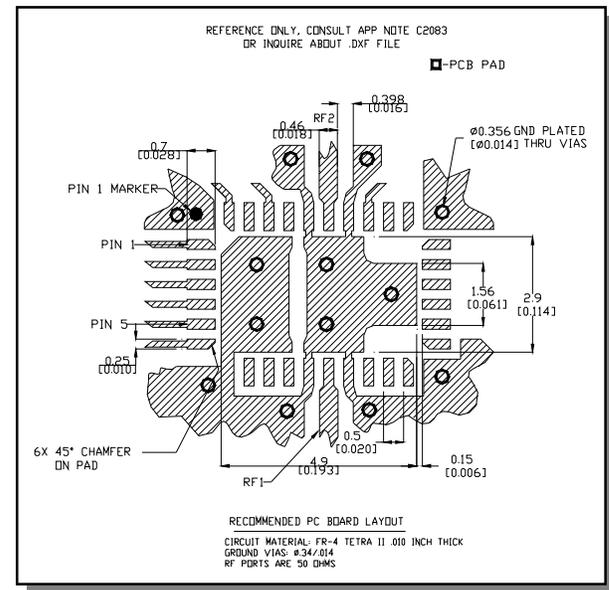
Parameter	Test Conditions	Frequency	Units	Min	Typ	Max
Insertion Loss	—	DC - 2.5 GHz	dB	—	2.7	3.0
Attenuation Accuracy	Individual Bits or Combination of Bits	DC - 2.5 GHz	dB	—	—	$\pm(.3 + 5\%$ of atten setting)
VSWR	Full Range	DC - 2.5 GHz	Ratio	—	1.5:1	1.8:1
Switching Speed	50% Cntl to 90%/10% RF 10% to 90% or 90% to 10%	— —	nS nS	— —	75 20	150 50
1 dB Compression	— —	50 MHz 0.5 - 2.5 GHz	dBm dBm	— —	+21 +29	— —
Input $IP_3$	Two-tone inputs up to +5 dBm	50 MHz 0.5 - 2.5 GHz	dB dB	— —	+35 +48	— —
$V_{CC}$ $V_{EE}$	— —	— —	V V	4.75 -8.0	5.0 -5.0	5.25 -4.75
$V_{IL}$ $V_{IH}$	LOW-level input voltage HIGH-level input voltage		V V	0.0 2.0	— —	0.8 5.0
$I_{in}$ (Input Leakage Current)	$V_{in} = V_{CC}$ or GND		uA	-1.0	—	1.0
$I_{CC}$ (Quiescent Supply Current)	$V_{cntrl} = V_{CC}$ or GND		uA	—	250	400
$\Delta I_{CC}$ (Additional Supply Current Per TTL Input Pin)	$V_{CC} = \text{Max}$ , $V_{cntrl} = V_{CC} - 2.1 \text{ V}$		mA	—	—	1.0
$I_{EE}$	$V_{EE}$ min to max, $V_{in} = V_{IL}$ or $V_{IH}$		mA	-1.0	-0.2	—
Thermal Resistance $\theta_{jc}$	—	—	$^\circ\text{C/W}$	—	15	—

**Absolute Maximum Ratings <sup>3,4</sup>**

Parameter	Absolute Maximum
Max. Input Power 0.05 GHz 0.5 - 2.5 GHz	+27 dBm +34 dBm
$V_{CC}$	$-0.5\text{V} \leq V_{CC} \leq +7.0\text{V}$
$V_{EE}$	$-8.5\text{V} \leq V_{EE} \leq +0.5\text{V}$
$V_{CC} - V_{EE}$	$-0.5\text{V} \leq V_{CC} - V_{EE} \leq 14.5\text{V}$
$V_{in}^5$	$-0.5\text{V} \leq V_{in} \leq V_{CC} + 0.5\text{V}$
Operating Temperature	$-40^\circ\text{C}$ to $+85^\circ\text{C}$
Storage Temperature	$-65^\circ\text{C}$ to $+125^\circ\text{C}$

- Exceeding any one or combination of these limits may cause permanent damage to this device.
- M/A-COM does not recommend sustained operation near these survivability limits.
- Standard CMOS TTL interface, latch-up will occur if logic signal is applied prior to power supply.

**Recommended PCB Configuration <sup>6</sup>**



6. Application Note C2083 is available on line at [www.macom.com](http://www.macom.com)

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**Handling Procedures**

Please observe the following precautions to avoid damage:

**Static Sensitivity**

Gallium Arsenide Integrated Circuits are sensitive to electrostatic discharge (ESD) and can be damaged by static electricity. Proper ESD control techniques should be used when handling these devices.

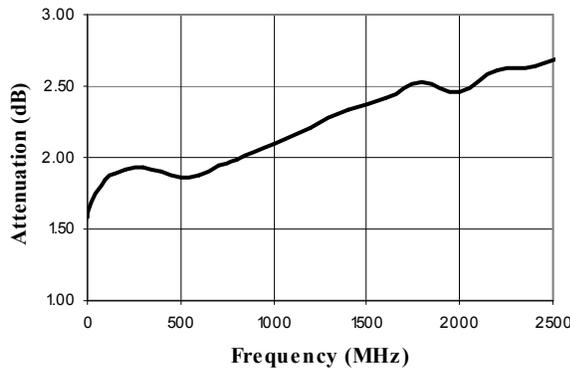
**Truth Table (Digital Attenuator)**

C16	C8	C4	C2	Attenuation
0	0	0	0	Loss, Reference
0	0	0	1	2.0 dB
0	0	1	0	4.0 dB
0	1	0	0	8.0 dB
1	0	0	0	16.0 dB
1	1	1	1	30.0 dB

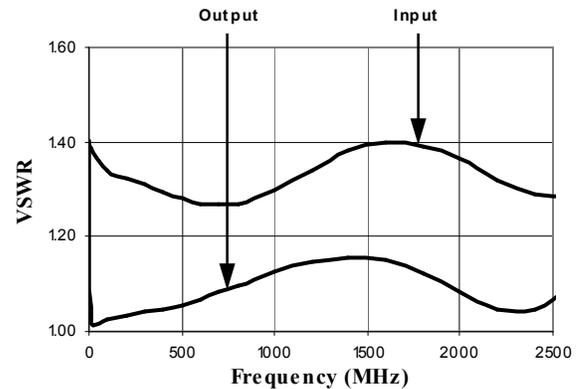
0 = TTL Low; 1 = TTL High

**Typical Performance Curves**

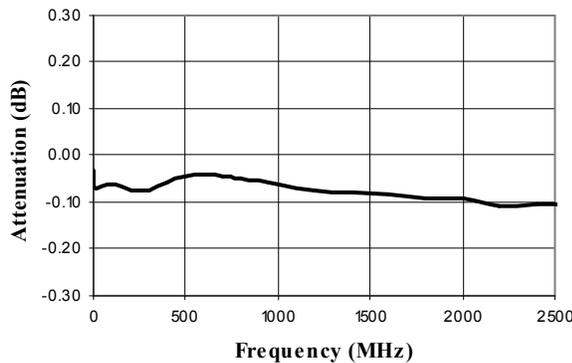
**Insertion Loss**



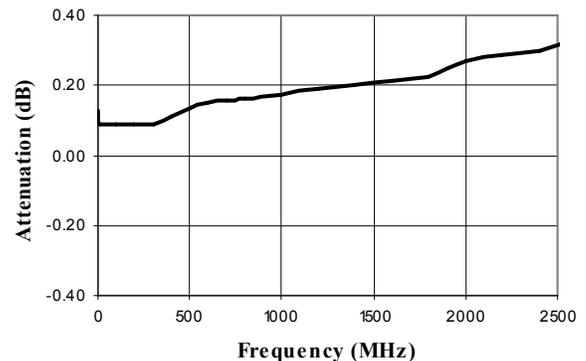
**VSWR @ Insertion Loss**



**Attenuation Error, 2 dB Bit**

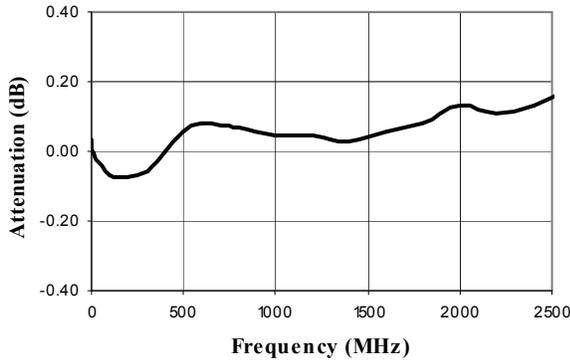


**Attenuation Error, 4 dB Bit**

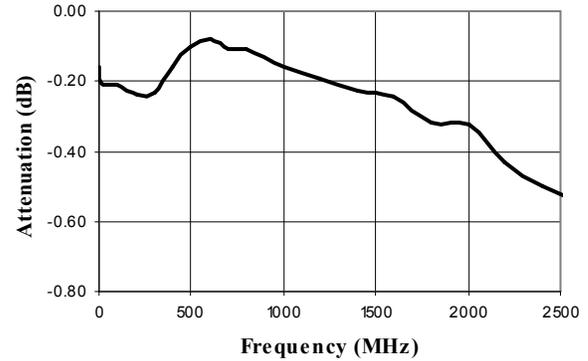


**Typical Performance Curves**

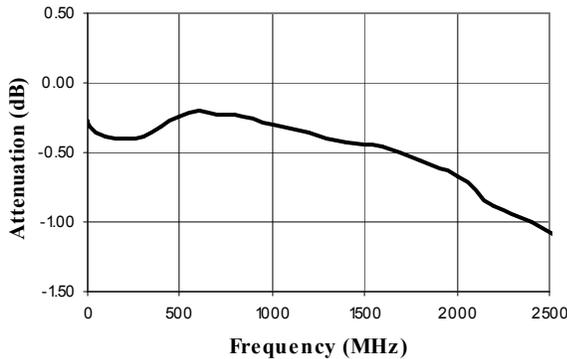
*Attenuation Error, 8 dB Bit*



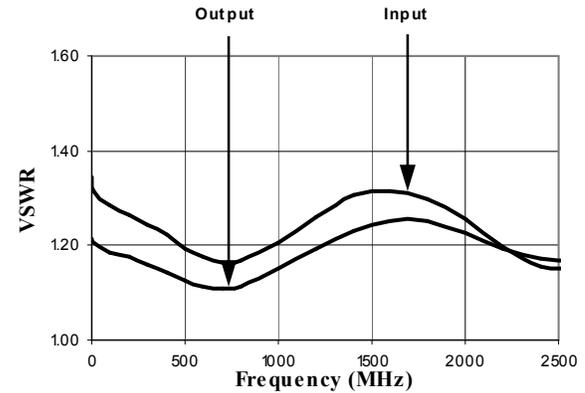
*Attenuation Error, 16 dB Bit*



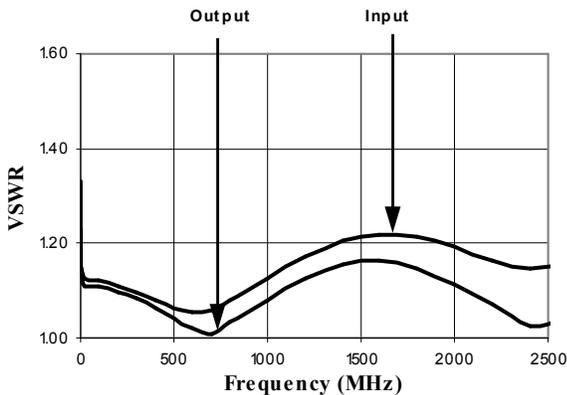
*Attenuation Error, Max. Attenuation*



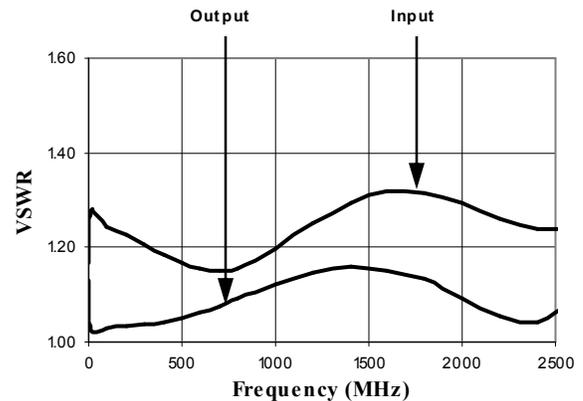
*VSWR, 2 dB Bit*



*VSWR, 4 dB Bit*



*VSWR, 8 dB Bit*

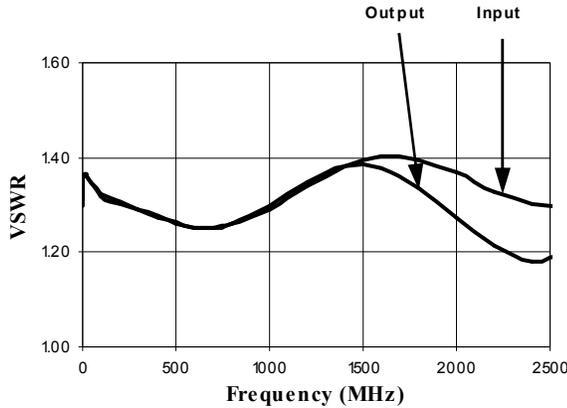


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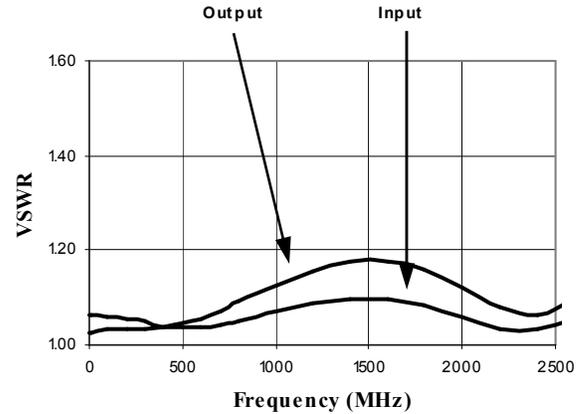
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**Typical Performance Curves**

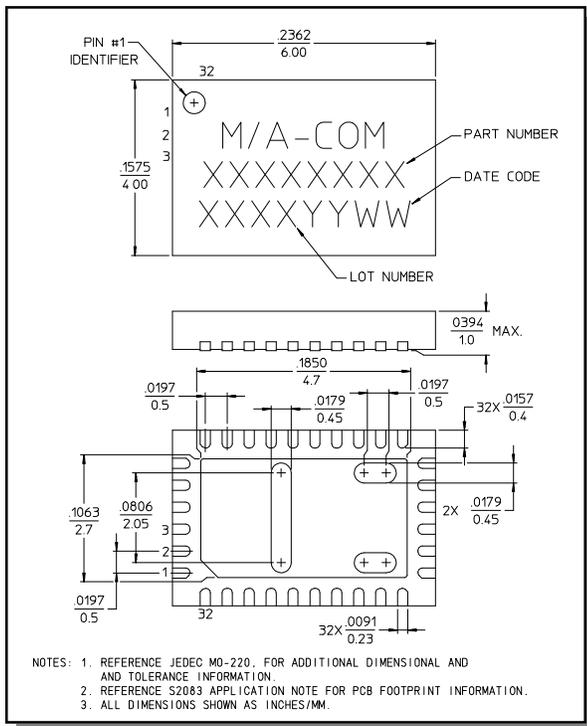
**VSWR, 16 dB Bit**



**VSWR, Maximum Attenuation**



**CSP-1, Lead-Free 4 x 6 mm, 32-lead  
PQFN†**



† Reference Application Note M538 for lead-free solder reflow recommendations.